

Appl. No. 10/795,839
Amdt. Dated July 5, 2005
Reply to Office Action of April 4, 2005

Attorney Docket No. 81788.0267
Customer No.: 26021

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1-20. (Canceled)

21. (Currently Amended) A light emitting device comprising:
a first lead;
a second lead;
a first semiconductor light emitting element mounted on said first lead;
a semiconductor element mounted on said first lead;
a first wire connecting said first semiconductor light emitting element and said second lead;
a second wire connecting said semiconductor element and said second lead;
and

a silicone resin provided to enclose said first semiconductor light emitting element, said semiconductor element, at least a part of said first lead, at least a part of said second lead, and said first and second wires, and ~~seeond~~ said silicone resin having a hardness not lower than 50 in JISA value.

22. (Previously Presented) A light emitting device according to claim 21, further comprising a third wire connecting said first semiconductor light emitting element and said first lead,

wherein said first lead having a slit formed therein between a portion where said first semiconductor light emitting element is mounted and a portion where said third wire is connected.

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23. (Previously Presented) A light emitting device according to claim 21, wherein said semiconductor element is a second semiconductor light emitting element.

24. (Previously Presented) A light emitting device according to claim 23, wherein said first semiconductor light emitting element and said second semiconductor light emitting element are different in peak wavelength of light they emit.

25. (Previously Presented) A light emitting device according to claim 21, wherein said silicone resin has a pre-curing viscosity in the range not lower than 100 cp and not higher than 10000 cp.

26. (Currently amended) A light emitting device according to claim 21, wherein said silicone resin ~~ha-s~~ has a convex surface configuration.

27. (Previously Presented) A light emitting device according to claim 21, wherein said silicone resin has a hardness not higher than 90 in JISA value.

28. (Previously Presented) A light emitting device according to claim 21, further comprising a fluorescent element which is included in said silicone resin, absorbs light emitted from said first semiconductor light emitting element and releases light of a peak wavelength different from said light from said first semiconductor light emitting element.

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29. (New) A light emitting device according to claim 21, wherein said semiconductor element is a Zener diode connected in parallel opposite direction to said first light emitting element.

30. (New) A light emitting device according to claim 28, further comprising a third wire connecting said first semiconductor light emitting element and said first lead,

wherein said first lead having a slit formed therein between a portion where said first semiconductor light emitting element is mounted and a portion where said third wire is connected.

31. (New) A light emitting device according to claim 28, wherein said semiconductor element is a second semiconductor light emitting element.

32. (New) A light emitting device according to claim 28, wherein said first semiconductor light emitting element and said second semiconductor light emitting element are different in peak wavelength of light they emit.

33. (New) A light emitting device according to claim 28, wherein said silicone resin has a pre-curing viscosity in the range not lower than 100 cp and not higher than 10000 cp.

34. (New) A light emitting device according to claim 28, wherein said silicone resin has a convex surface configuration.

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35. (New) A light emitting device according to claim 28, wherein said silicone resin has a hardness not higher than 90 in JISA value.

36. (New) A light emitting device according to claim 28, wherein said semiconductor element is a Zener diode connected in parallel opposite direction to said first light emitting element.